



**RS6331S, RS6332S
RS6331, RS6332, RS6334**

1.1MHz, Rail-to-Rail I/O CMOS Operational Amplifier

FEATURES

- **HIGH GAIN BANDWIDTH:1.1MHz**
- **RAIL-TO-RAIL INPUT AND OUTPUT**
0.6mV Typical Vos
- **INPUT VOLTAGE RANGE: -0.1V to +5.6V**
with Vs = 5.5V
- **SUPPLY RANGE: +2.5V to +5.5V**
- **SHUTDOWN: RS6331S/RS6332S**
- **SPECIFIED UP TO +125°C**
- **MicroSIZE PACKAGES: SOT23-5, SOT23-6**

APPLICATIONS

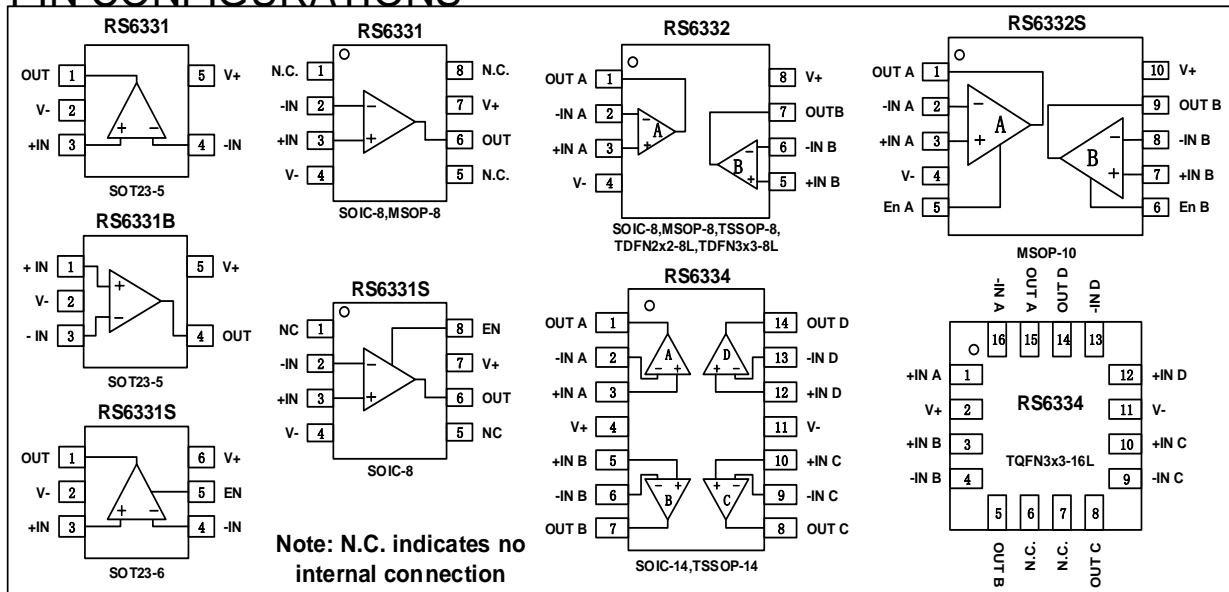
- **SENSORS**
- **PHOTODIODE AMPLIFICATION**
- **ACTIVE FILTERS**
- **TEST EQUIPMENT**
- **DRIVING A/D CONVERTERS**

DESCRIPTION

The RS6331, RS6332, RS6334, RS6331S, RS6332S families of products offer low voltage operation and rail-to-rail input and output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (1.1MHz) and slew rate of 0.5V/us. The op-amps are unity gain stable and feature an ultra-low input bias current.

The devices are ideal for sensor interfaces, active filters and portable applications. The RS6331S, RS6332S include a shutdown mode. Under logic control, the amplifiers can be switched from normal operation to a standby current that is less than 1uA. The RS6331, RS6332, RS6334, RS6331S, RS6332S families of operational amplifiers are specified at the full temperature range of -40°C to +125°C under single or dual power supplies of 2.5V to 5.5V.

PIN CONFIGURATIONS





ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Supply Voltage, V+ to V-	7.0V
Input Terminals, Voltage ⁽²⁾	- 0.5 to (V+) + 0.5V
Current ⁽²⁾	±10mA
Storage Temperature	-65°C to +150°C
Operating Temperature	-40°C to +125°C
Junction Temperature	150°C
Package Thermal Resistance @ T _A = +25°C	
SOT23-5, SOT23-6	200°C/W
MSOP-10, SOIC-8, TSSOP-8	150°C/W
SOIC-14, TSSOP-14	100°C/W
Lead Temperature (Soldering, 10s)	260°C
ESD Susceptibility	
HBM	5000V
MM	400V



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.

PACKAGE/ORDERING INFORMATION

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING	PACKAGE OPTION
RS6331	RS6331XK	-40°C~125°C	SOIC-8	RS6331	Tape and Reel,2500
	RS6331XF	-40°C~125°C	SOT23-5	6331	Tape and Reel,3000
	RS6331BXF	-40°C~125°C	SOT23-5	6331B	Tape and Reel,3000
	RS6331XM	-40°C~125°C	MSOP-8	RS6331	Tape and Reel,3000
RS6331S	RS6331S XK	-40°C~125°C	SOIC-8	RS6331S	Tape and Reel,2500
	RS6331S XH	-40°C~125°C	SOT23-6	6331S	Tape and Reel,3000
RS6332	RS6332XK	-40°C~125°C	SOIC-8	RS6332	Tape and Reel,2500
	RS6332XM	-40°C~125°C	MSOP-8	RS6332	Tape and Reel,3000
	RS6332XTDE8	-40°C~125°C	TDFN2x2-8L	RS6332	Tape and Reel,3000
	RS6332XTDC8	-40°C~125°C	TDFN3x3-8L	RS6332	Tape and Reel,3000
	RS6332XQ	-40°C~125°C	TSSOP-8	RS6332	Tape and Reel,3000
RS6332S	RS6332SXN	-40°C~125°C	MSOP-10	RS6332S	Tape and Reel,3000
RS6334	RS6334XP	-40°C~125°C	SOIC -14	RS6334	Tape and Reel,2500
	RS6334XQ	-40°C~125°C	TSSOP-14	RS6334	Tape and Reel,3000
	RS6334XTQC16	-40°C~125°C	TQFN3x3-16L	RS6334	Tape and Reel,3000



ELECTRICAL CHARACTERISTICS

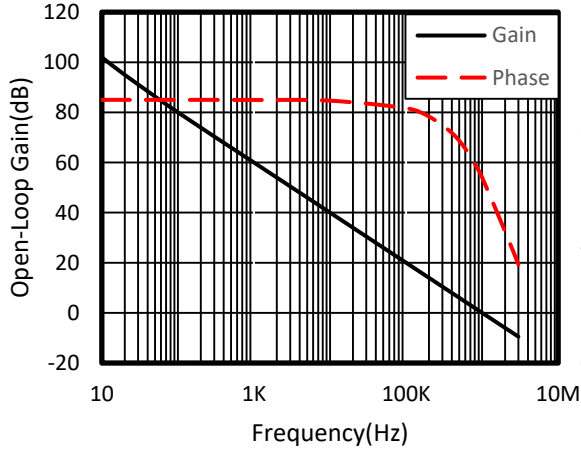
(At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, and $V_{OUT} = V_S/2$, unless otherwise noted.)

PARAMETER	CONDITIONS	T_J	RS6331S,RS6332S, RS6331,RS6332,RS6334			UNIT	
			MIN	TYP	MAX		
POWER SUPPLY							
V_S	Operating Voltage Range		25°C	2.5	5.5	V	
I_Q	Quiescent Current/Amplifier		25°C		58	80	μA
PSRR	Power-Supply Rejection Ratio	$V_S = 2.5\text{V to } 5.5\text{V}$ $V_{cm} = (V_-) + 0.5\text{V}$	25°C	72	90	dB	
			$-40^\circ\text{C to } 125^\circ\text{C}$	65			
INPUT							
V_{os}	Input Offset Voltage	$V_{cm} = V_S/2$	25°C		0.6	3	mV
$V_{os\ TC}$	Input Offset Voltage Drift	$-40^\circ\text{C to } 125^\circ\text{C}$			2		$\mu\text{V}/^\circ\text{C}$
I_B	Input Bias Current		25°C		1	10	pA
I_{os}	Input Offset Current		25°C		1	10	pA
V_{cm}	Common-Mode Voltage Range	$V_S = 5.5\text{V}$	25°C	-0.1		5.6	V
CMRR	Common-Mode Rejection Ratio	$V_S = 5.5\text{V}$, $V_{cm} = -0.1\text{V to } 4\text{V}$	25°C	71	90	dB	
			$-40^\circ\text{C to } 125^\circ\text{C}$	68			
			25°C	60	80		
			$-40^\circ\text{C to } 125^\circ\text{C}$	57			
OUTPUT							
AOL	Open-Loop Voltage Gain	$R_L = 2\text{k}\Omega$, $V_o = 0.15\text{V to } 4.85\text{V}$	25°C	94	105	dB	
			$-40^\circ\text{C to } 125^\circ\text{C}$	85			
			25°C	100	110		
			$-40^\circ\text{C to } 125^\circ\text{C}$	90			
	Output Swing From Rail	$R_L = 2\text{k}\Omega$	25°C		25	mV	
		$R_L = 10\text{k}\Omega$	25°C		8		
I_{out}	Output Short-Circuit Current		25°C		55	mA	
FREQUENCY RESPONSE							
SR	Slew Rate		25°C		0.5	V/ μs	
GBP	Gain-Bandwidth Product		25°C		1.1	MHz	
Φ_m	Phase Margin		25°C		64	$^\circ$	
t_s	Settling Time, 0.1%		25°C		1.3	μs	
	Overload Recovery Time	$V_{IN} \cdot \text{Gain} \geq V_S$	25°C		2.3	μs	
NOISE							
e_n	Input-Referred Voltage Noise	$f = 1\text{ kHz}$	25°C		22	$\text{nV}/\sqrt{\text{Hz}}$	
		$f = 10\text{ kHz}$	25°C		20	$\text{nV}/\sqrt{\text{Hz}}$	
ENABLE/SHUTDOWN(RS6331S,RS6332S)							
$I_{Q(OFF)}$	Supply Current in Shutdown		25°C		<1	μA	
t_{OFF}			25°C		3	μs	
t_{ON}			25°C		20	μs	
V_L	Shut Down		25°C	V_-		$(V_-) + 0.8$	V
V_H	Amplifier Is Active		25°C	$(V_-) + 2$		V_+	V

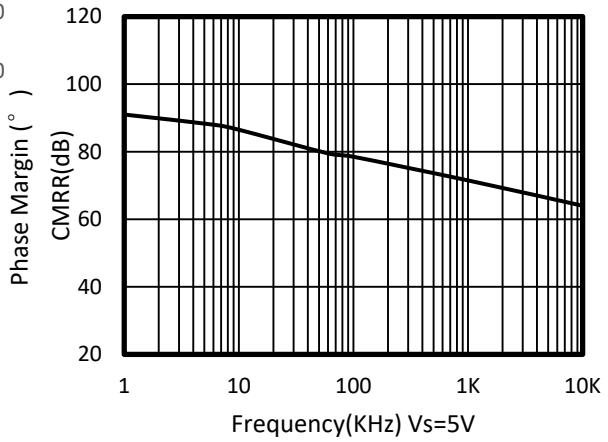
TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

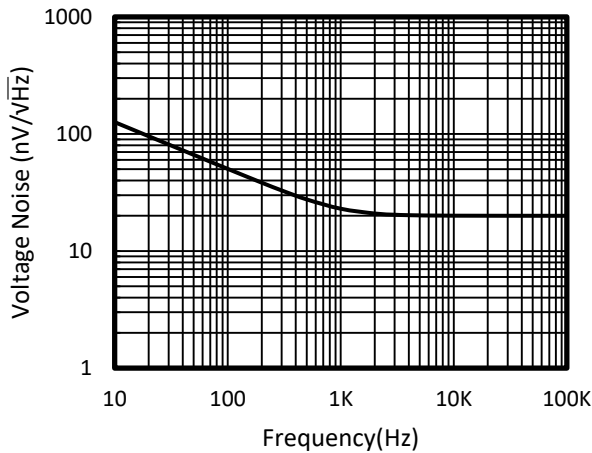
OPEN-LOOP GAIN AND PHASE vs FREQUENCY



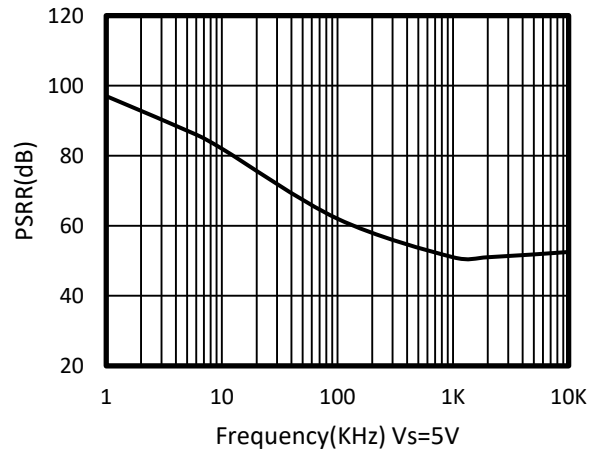
COMMON-MODE REJECTION RATIO vs FREQUENCY



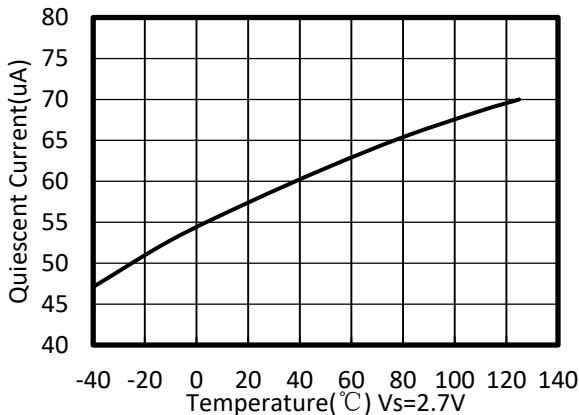
INPUT VOLTAGE NOISE SPECTRAL DENSITY vs FREQUENCY



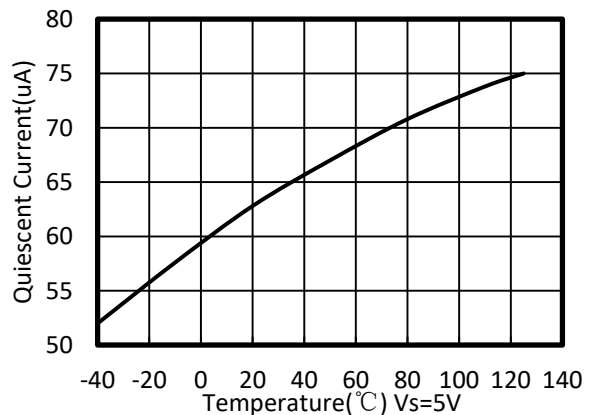
POWER-SUPPLY REJECTION RATIO vs FREQUENCY



QUIESCENT CURRENT vs TEMPERATURE



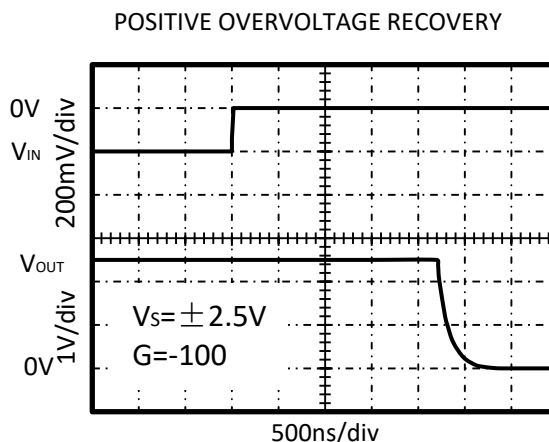
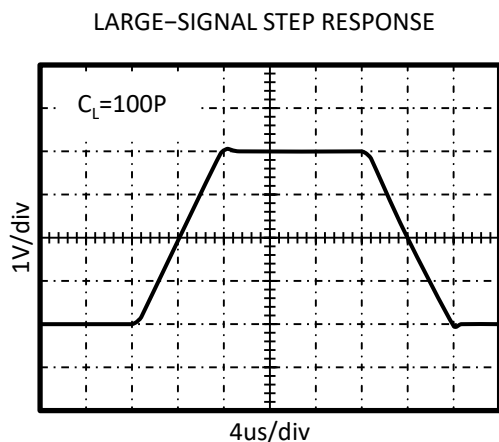
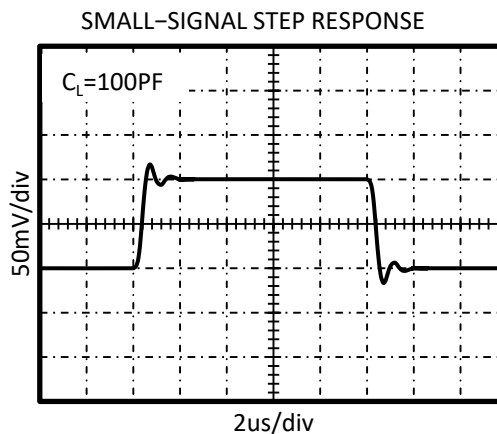
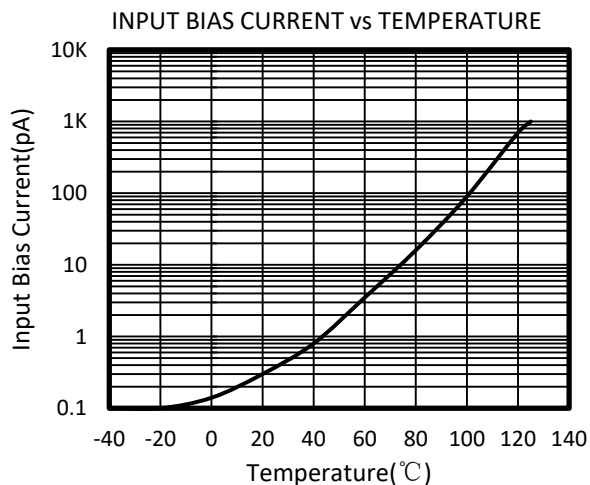
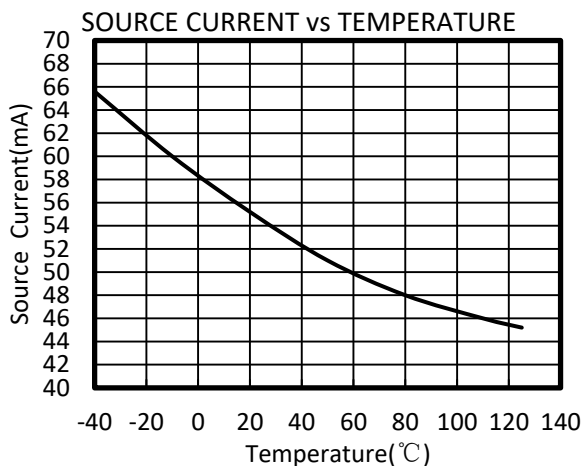
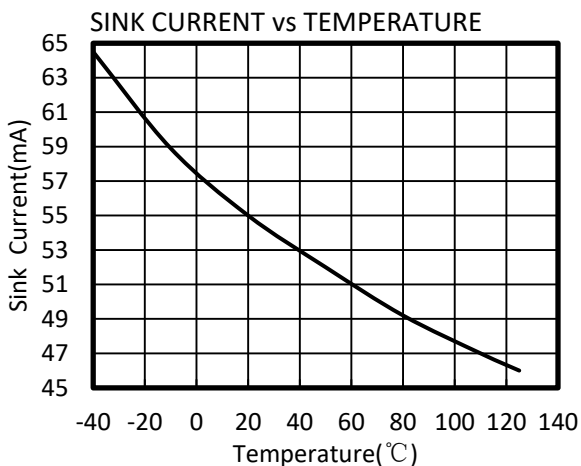
QUIESCENT CURRENT vs TEMPERATURE





TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

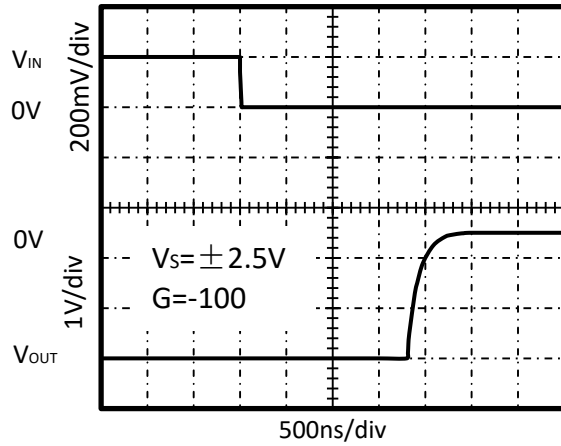




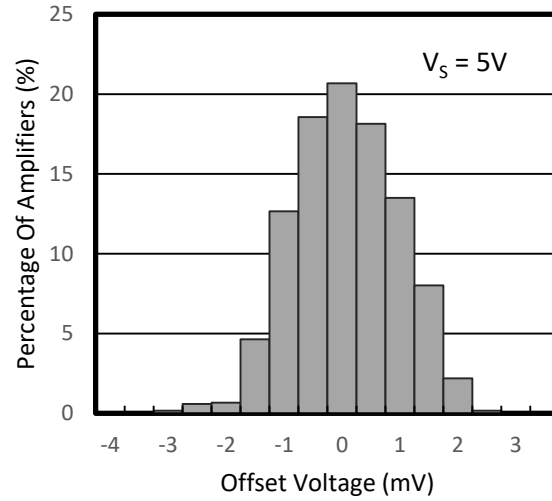
TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

Negative Overvoltage Recovery



Offset Voltage Production Distribution



APPLICATION NOTES

The RS6331, RS6332, RS6334, RS6331S, RS6332S are high precision, rail-to-rail operational amplifiers that can be run from a single-supply voltage 2.5V to 5.5V ($\pm 1.25V$ to $\pm 2.75V$). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier.

Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications.

Good layout practice mandates use of a 0.1uF capacitor place closely across the supply pins.

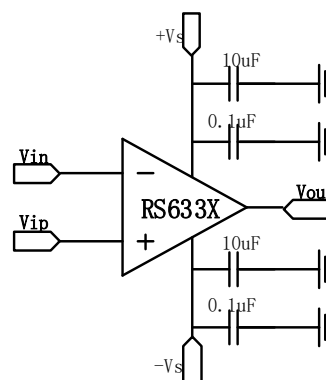


Figure1. Amplifier with Bypass Capacitors

RS6331S/RS6332S ENABLE FUNCTION

The RS6331S/RS6332S includes a shutdown mode. Under logic control, the amplifiers can be switched from normal mode to a standby current of 1uA. When the Enable pin is connected to high, the amplifier is active. Connecting Enable low disables the amplifier, and places the amplifier, and place the output in a high-impedance state.

LAYOUT GUIDELINS

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1uF capacitor closely across the supply pins.

These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.

INSTRUMENTATION AMPLIFIER

In the three-op amp, instrumentation amplifier configuration shown in Figure2,

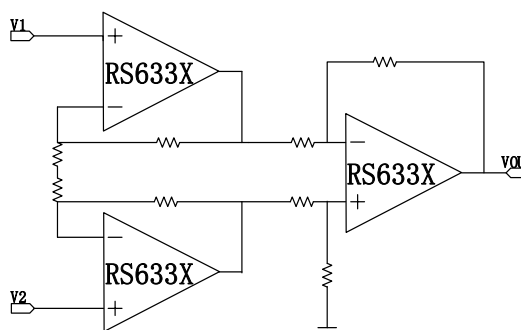
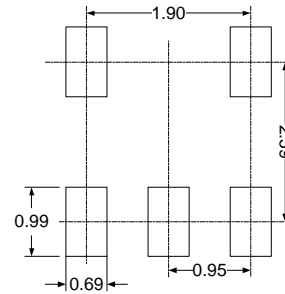
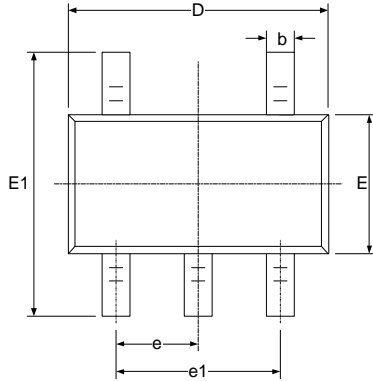


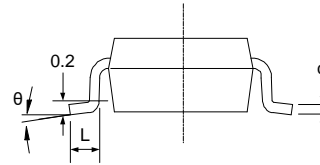
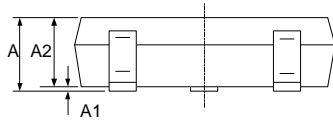
Figure2. Amplifier instrumentation amplifier

PACKAGE OUTLINE DIMENSIONS

SOT23-5

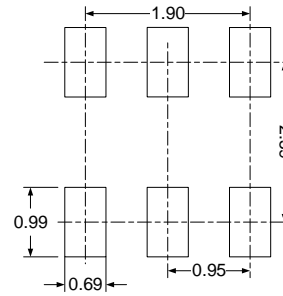
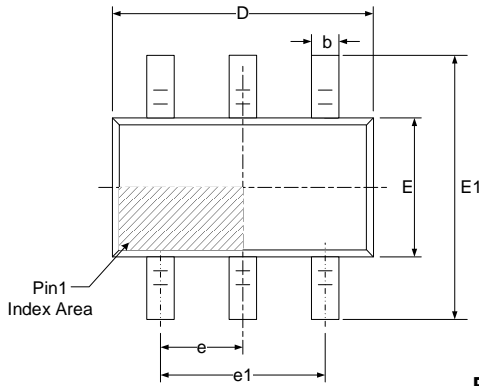


RECOMMENDED LAND PATTERN (Unit: mm)

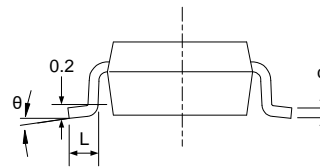
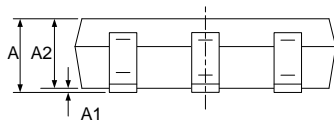


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

SOT23-6

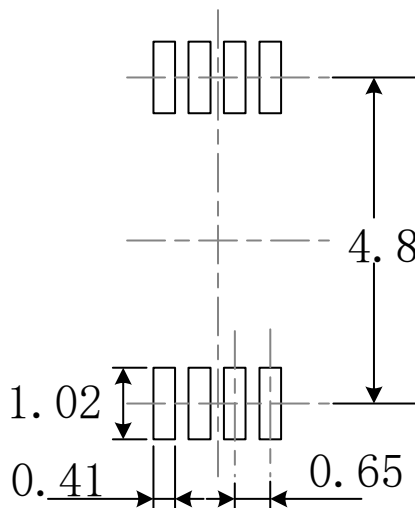
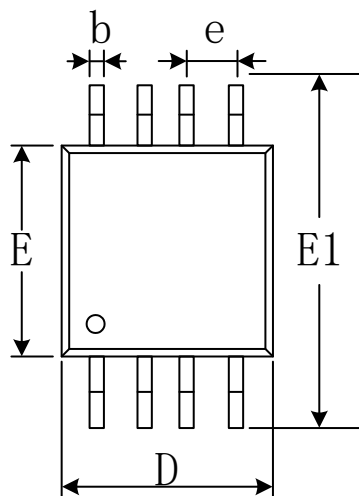


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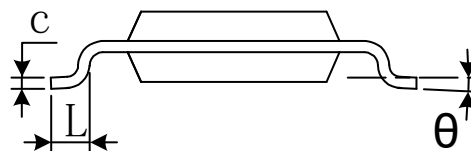
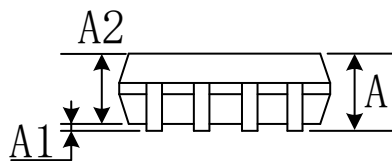


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

MSOP-8

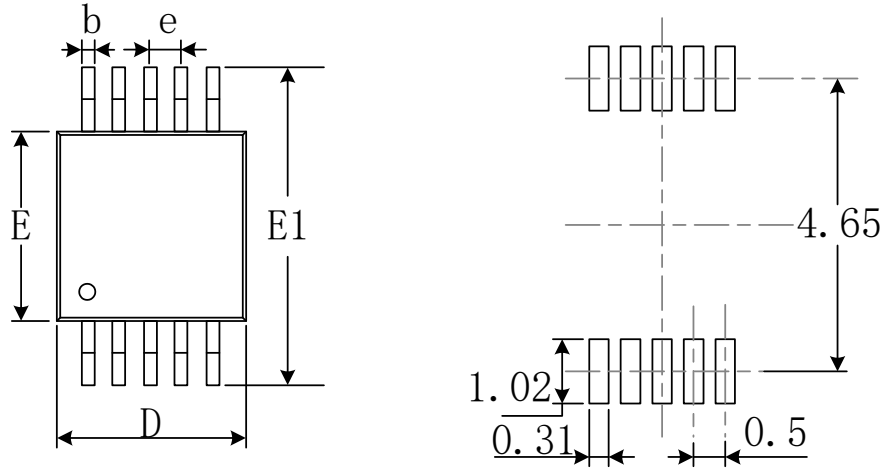


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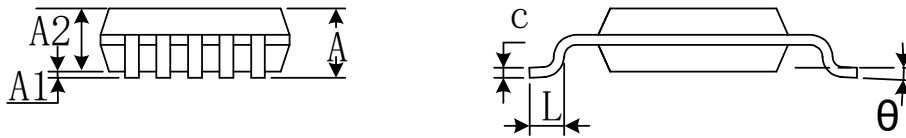


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.650(BSC)		0.026(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

MSOP-10

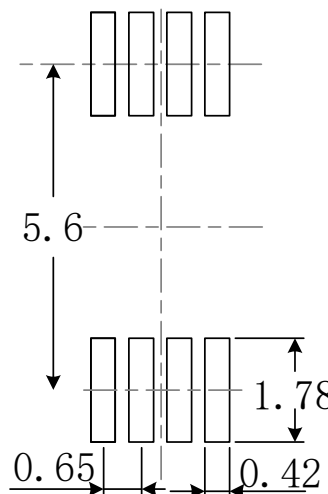
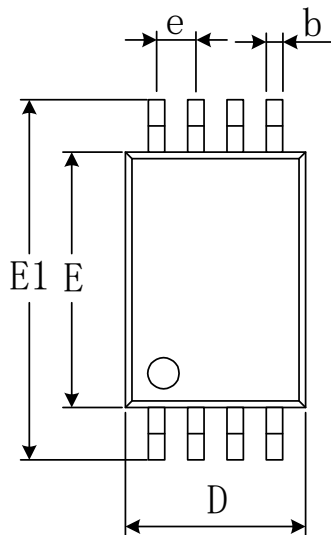


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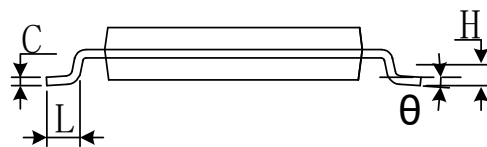
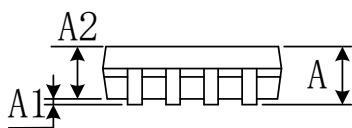


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.180	0.280	0.007	0.011
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.50(BSC)		0.020(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

TSSOP-8

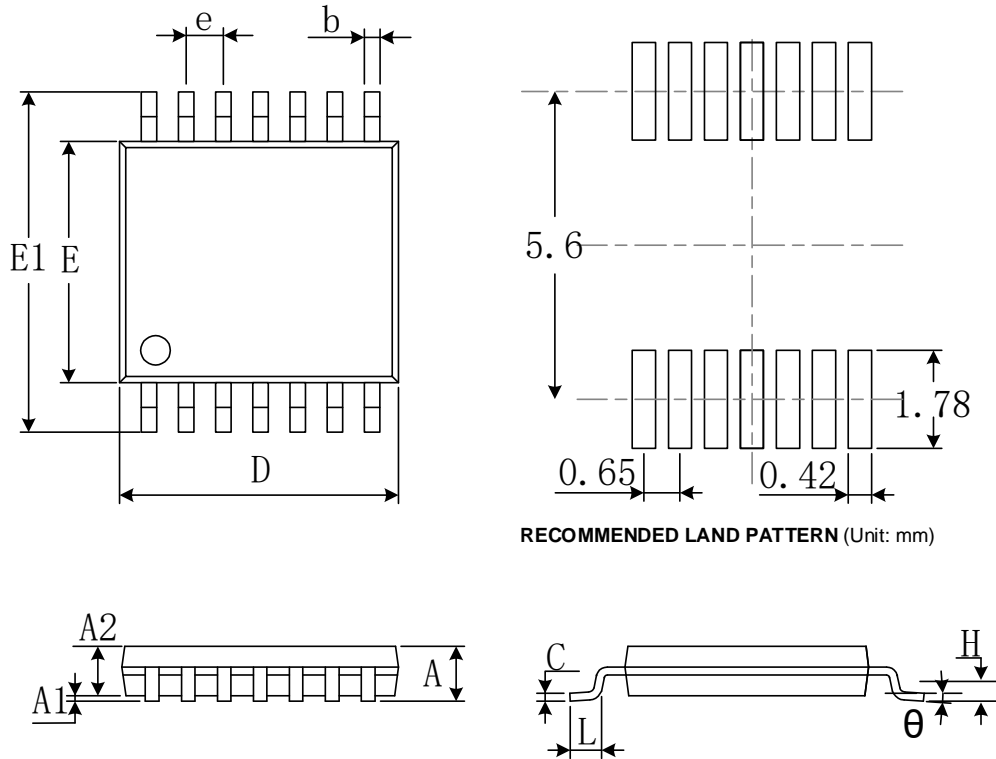


RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	2.900	3.100	0.114	0.122
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650(BSC)		0.026(BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

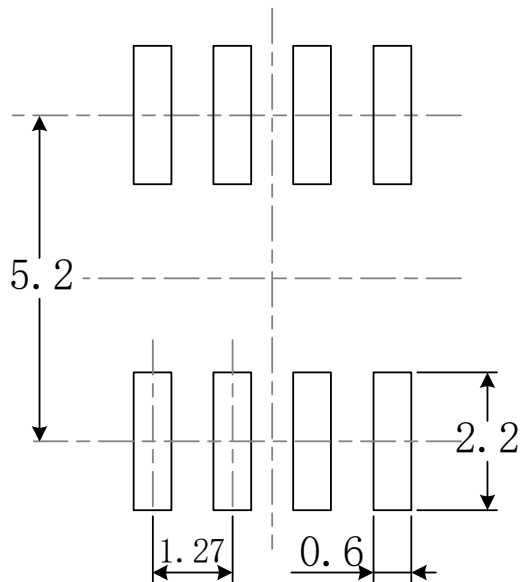
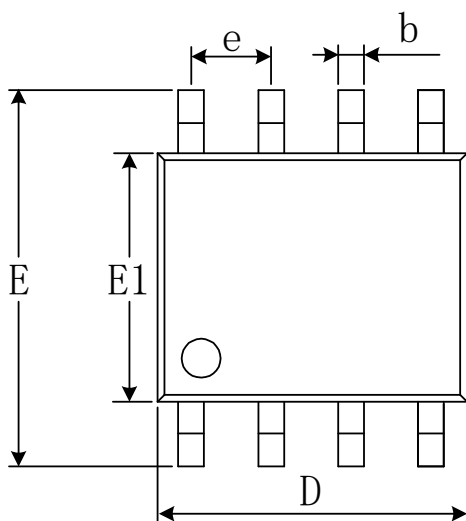
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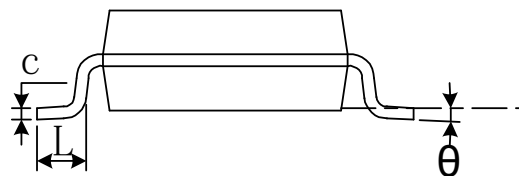
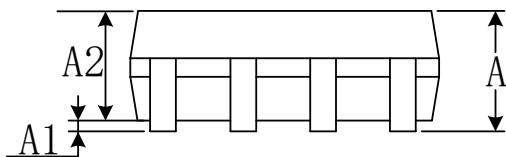
RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650(BSC)		0.026(BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

SOIC-8

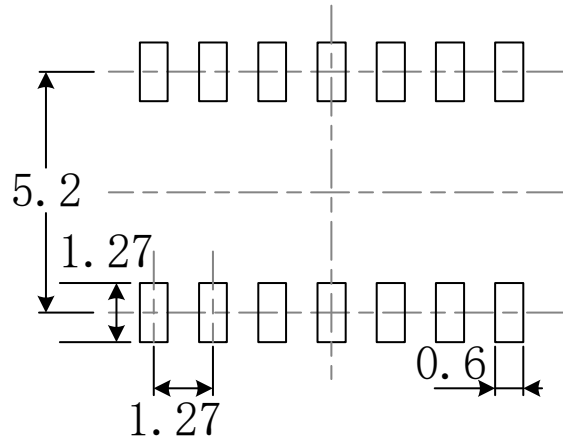
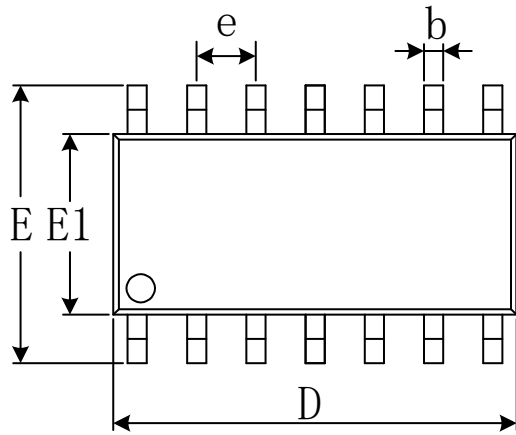


RECOMMENDED LAND PATTERN (Unit: mm)

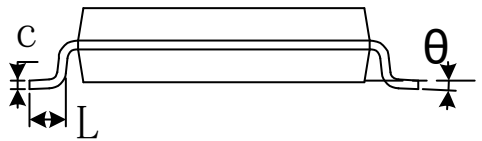
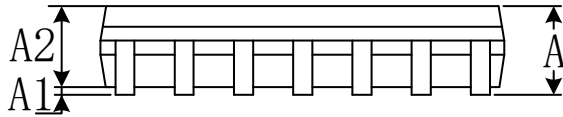


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

SOIC-14

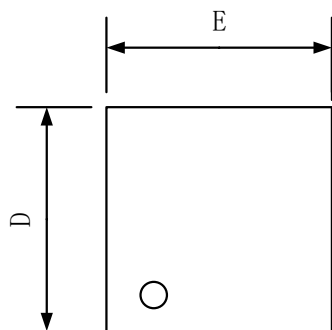


RECOMMENDED LAND PATTERN (Unit: mm)

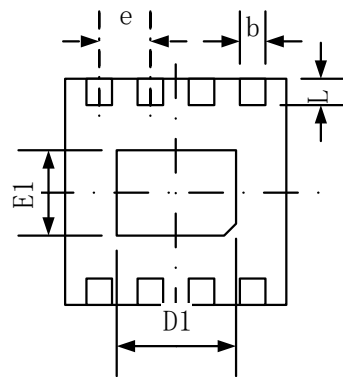


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.310	0.510	0.012	0.020
c	0.100	0.250	0.004	0.010
D	8.450	8.850	0.333	0.348
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

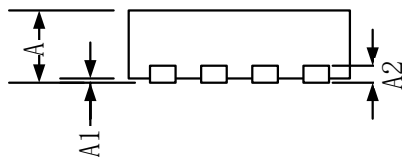
TDFN-2x2-8L



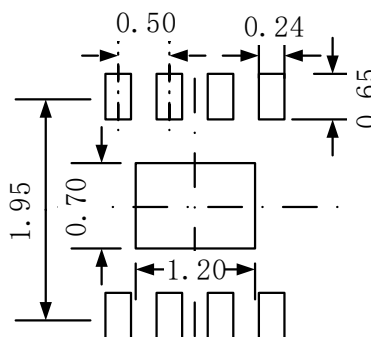
TOP VIEW



BOTTOM VIEW



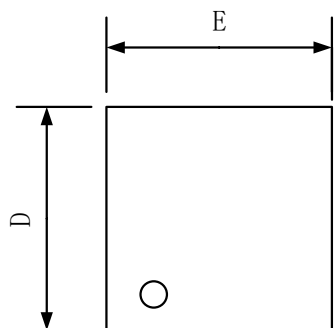
SIDE VIEW



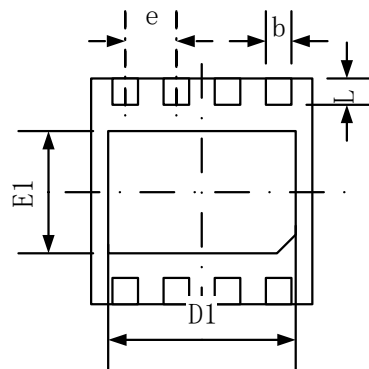
RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203(TYP)		0.008(TYP)	
b	0.180	0.300	0.007	0.012
D	1.900	2.100	0.075	0.083
D1	1.100	1.300	0.043	0.051
E	1.900	2.100	0.075	0.083
E1	0.600	0.800	0.024	0.031
e	0.500(TYP)		0.020(TYP)	
L	0.250	0.450	0.010	0.018

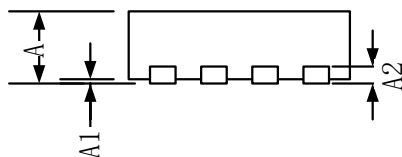
TDFN-3x3-8L



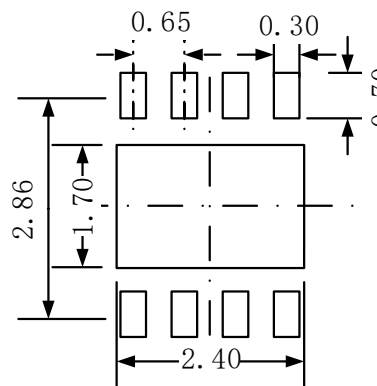
TOP VIEW



BOTTOM VIEW



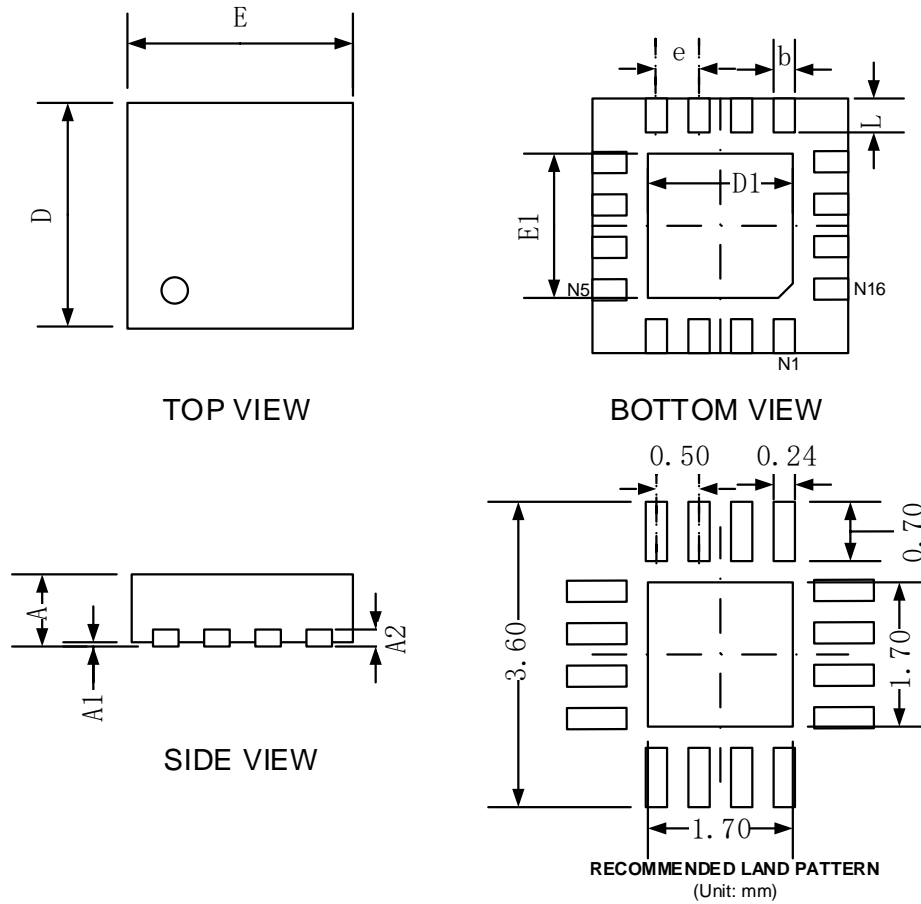
SIDE VIEW



RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203		0.008	
b	0.250	0.350	0.010	0.014
D	2.900	3.100	0.114	0.122
D1	2.350	2.450	0.093	0.096
E	2.900	3.100	0.114	0.122
E1	1.650	1.750	0.065	0.069
e	0.650 TYP		0.026 TYP	
L	0.370	0.470	0.015	0.019

TQFN-3x3-16L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203		0.008	
b	0.180	0.300	0.007	0.012
D	2.900	3.100	0.114	0.122
D1	1.600	1.800	0.063	0.071
E	2.900	3.100	0.114	0.122
E1	1.600	1.800	0.063	0.071
e	0.500 TYP		0.020 TYP	
L	0.300	0.500	0.012	0.020